

L Number	Hits	Search Text	DB	Time stamp
1	379	"smart cut"	USPAT; US-PGPUB	2004/06/23 09:48
2	1242	"micro bubble" or microbubble	USPAT; US-PGPUB	2004/06/23 09:49
3	16	"smart cut" and ("micro bubble" or microbubble)	USPAT; US-PGPUB	2004/06/23 09:55
4	23067	RMS	USPAT; US-PGPUB	2004/06/23 10:27
5	53973	RMS or "surface roughness"	USPAT; US-PGPUB	2004/06/23 10:27
6	3	("smart cut" and ("micro bubble" or microbubble)) and RMS	USPAT; US-PGPUB	2004/06/23 10:28
7	98	"smart cut" and (RMS or "surface roughness")	USPAT; US-PGPUB	2004/06/23 10:28
8	1058507	@ad>19991014 or @rlad>19991014	USPAT; US-PGPUB	2004/06/23 10:28
9	26	("smart cut" and (RMS or "surface roughness")) not (@ad>19991014 or @rlad>19991014)	USPAT; US-PGPUB	2004/06/23 11:12
10	536770	square	USPAT; US-PGPUB	2004/06/23 10:33
11	12	(("smart cut" and (RMS or "surface roughness")) not (@ad>19991014 or @rlad>19991014)) and square	USPAT; US-PGPUB	2004/06/23 10:34
12	313	438/406.ccls.	USPAT; US-PGPUB	2004/06/23 10:35
13	40	(RMS or "surface roughness") and 438/406.ccls.	USPAT; US-PGPUB	2004/06/23 10:35
14	34	((RMS or "surface roughness") and 438/406.ccls.) not ("smart cut" and (RMS or "surface roughness")) not (@ad>19991014 or @rlad>19991014)	USPAT; US-PGPUB	2004/06/23 10:35
15	17	((RMS or "surface roughness") and 438/406.ccls.) not ("smart cut" and (RMS or "surface roughness")) not (@ad>19991014 or @rlad>19991014)) not (@ad>19991014 or @rlad>19991014)	USPAT; US-PGPUB	2004/06/23 10:35
16	246	148/dig.12.ccls.	USPAT; US-PGPUB	2004/06/23 11:12
-	2	((5937312") or ("5834812")).PN.	USPAT; US-PGPUB	2004/06/23 07:50
-	1	("6737298").PN.	USPAT; US-PGPUB	2004/06/23 07:53
-	26966	delaminat\$3	USPAT; US-PGPUB	2004/06/23 08:13
-	685610	bond\$3	USPAT; US-PGPUB	2004/06/23 07:54
-	25	delaminat\$3 and ("micro bubble" or microbubble) and bond\$3	USPAT; US-PGPUB	2004/06/23 07:54
-	11	(delaminat\$3 and ("micro bubble" or microbubble) and bond\$3) not (@ad>19991014 or @rlad>19991014)	USPAT; US-PGPUB	2004/06/23 08:02
-	1	delaminat\$3 and ("micro bubble" or microbubble) and 438/406.ccls.	USPAT; US-PGPUB	2004/06/23 08:02
-	486	438/458.ccls.	USPAT; US-PGPUB	2004/06/23 08:03
-	5	delaminat\$3 and ("micro bubble" or microbubble) and 438/458.ccls.	USPAT; US-PGPUB	2004/06/23 08:03
-	1	(delaminat\$3 and ("micro bubble" or microbubble) and 438/458.ccls.) not (@ad>19991014 or @rlad>19991014)	USPAT; US-PGPUB	2004/06/23 08:03
-	55	438/506.ccls.	USPAT; US-PGPUB	2004/06/23 08:03
-	0	delaminat\$3 and ("micro bubble" or microbubble) and 438/506.ccls.	USPAT; US-PGPUB	2004/06/23 08:03
-	358	438/514.ccls.	USPAT; US-PGPUB	2004/06/23 08:03
-	0	delaminat\$3 and ("micro bubble" or microbubble) and 438/514.ccls.	USPAT; US-PGPUB	2004/06/23 08:03
-	340	438/528.ccls.	USPAT; US-PGPUB	2004/06/23 08:04
-	0	delaminat\$3 and ("micro bubble" or microbubble) and 438/528.ccls.	USPAT; US-PGPUB	2004/06/23 08:04

-	507	438/977.cccls.	USPAT; US-PGPUB	2004/06/23 08:04
-	3	delaminat\$3 and ("micro bubble" or microbubble) and 438/977.cccls.	USPAT; US-PGPUB	2004/06/23 08:05
-	116	438/for.365.cccls.	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:11
-	372	438/for.386.cccls.	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:11
-	139	438/for.403.cccls.	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:11
-	142	438/for.408.cccls.	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:11
-	396	438/for.158.cccls.	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:11
-	114	438/for.485.cccls.	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:11
-	9876	delaminat\$3	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:13
-	602	"micro bubble" or microbubble	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:13
-	3	delaminat\$3 and ("micro bubble" or microbubble)	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:14
-	0	438/for.365.cccls. and ("micro bubble" or microbubble)	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:14
-	0	438/for.386.cccls. and ("micro bubble" or microbubble)	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:14
-	0	438/for.403.cccls. and ("micro bubble" or microbubble)	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:14
-	0	438/for.408.cccls. and ("micro bubble" or microbubble)	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:14
-	0	438/for.158.cccls. and ("micro bubble" or microbubble)	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:14
-	0	438/for.485.cccls. and ("micro bubble" or microbubble)	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:17
-	0	"CZ wafer" with bond	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:18
-	0	"CZ wafer" with "crystal ingot"	EPO; JPO; DERWENT; IBM_TDB	2004/06/23 08:18
-	7	"CZ wafer" with bond	USPAT; US-PGPUB	2004/06/23 08:19
-	3	"CZ wafer" with "crystal ingot"	USPAT; US-PGPUB	2004/06/23 08:21